2/13/03 HByes entered 3-12-03 J. atti EXPEDITED PROCEDURE **GROUP ART UNIT 2814** 

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: JEUN et al. Serial No.: 09/677,558 Title: SEMICONDUCTOR POWER

MODULE HAVING AN ELECTRICALLY INSULATING HEAT SINK AND METHOD OF MANUFACTURING THE

SAME

Filed: September 29, 2000 Group Art Unit: 2814

Examiner: DiLinh Nguyen

I hereby certify that this paper is being facsimile transmitted to the United States Patent and Trademark Office, Fax. No. (703) 308-7722, on the date shown

below:

February 6, 2003

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## RESPONSE TO FINAL OFFICIAL ACTION

FEB **6** 2003

**TECHNOLOGY CENTER 2800** 

Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the final official action dated November 6, 2002 the applicants respectfully request that the application be reconsidered in light of the following amendment and remarks.

## In The Drawings:

Please amend the drawings as indicated in the enclosed Request for Approval of Drawing Changes.

## **REMARKS**

The outstanding objections to the drawings is respectfully traversed. The applicants respectfully submit that the above amendments overcome such objections and therefore request reconsideration and withdrawal of the same.